

IRGPS40B120UP

INSULATED GATE BIPOLAR TRANSISTOR

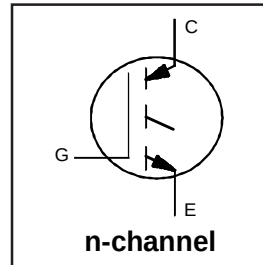
UltraFast IGBT

Features

- Non Punch Through IGBT Technology.
- 10µs Short Circuit Capability.
- Square RBSOA.
- Positive VCE (on) Temperature Coefficient.
- Super-247 Package.
- Lead-Free

Benefits

- Benchmark Efficiency for Motor Control.
- Rugged Transient Performance.
- Low EMI.
- Significantly Less Snubber Required
- Excellent Current Sharing in Parallel Operation.



$V_{CES} = 1200V$
 $V_{CE(on)} \text{ typ.} = 3.12V$
 @ $V_{GE} = 15V$,
 $I_{CE} = 40A, T_j = 25^\circ C$



Super-247™

Absolute Maximum Ratings

	Parameter	Max.	Units
V_{CES}	Collector-to-Emitter Voltage	1200	V
$I_C @ T_C = 25^\circ C$	Continuous Collector Current	80	A
$I_C @ T_C = 100^\circ C$	Continuous Collector Current	40	
I_{CM}	Pulsed Collector Current	160	
I_{LM}	Clamped Inductive Load Current ①	160	
V_{GE}	Gate-to-Emitter Voltage	± 20	V
$P_D @ T_C = 25^\circ C$	Maximum Power Dissipation	595	W
$P_D @ T_C = 100^\circ C$	Maximum Power Dissipation	238	
T_J	Operating Junction and	-55 to +150	$^\circ C$
T_{STG}	Storage Temperature Range		
	Soldering Temperature, for 10 sec.	300 (0.063 in. (1.6mm) from case)	

Thermal Resistance

	Parameter	Min.	Typ.	Max.	Units
$R_{\theta JC}$	Junction-to-Case - IGBT	—	—	0.20	$^\circ C/W$
$R_{\theta CS}$	Case-to-Sink, flat, greased surface	—	0.24	—	
$R_{\theta JA}$	Junction-to-Ambient, typical socket mount	—	—	40	
	Recommended Clip Force	20 (2)	—	—	N(kgf)
Wt	Weight	—	6.0 (0.21)	—	g (oz)
Le	Internal Emitter Inductance (5mm from package)	—	13	—	nH

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Electrical Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

	Parameter	Min.	Typ.	Max.	Units	Conditions	Ref.Fig.
$V_{(BR)CES}$	Collector-to-Emitter Breakdown Voltage	1200	—	—	V	$V_{GE} = 0V, I_C = 500\mu A$	
$\Delta V_{(BR)CES}/\Delta T_J$	Temperature Coeff. of Breakdown Voltage	—	0.40	—	V/ $^\circ\text{C}$	$V_{GE} = 0V, I_C = 1.0mA, (25^\circ\text{C}-125^\circ\text{C})$	
$V_{CE(on)}$	Collector-to-Emitter Saturation Voltage	—	3.12	3.40	V	$I_C = 40A, V_{GE} = 15V$	5, 6
		—	3.39	3.71		$I_C = 50A$	7, 9
		—	3.88	4.39		$I_C = 40A, T_J = 125^\circ\text{C}$	10
		—	4.24	4.79		$I_C = 50A, T_J = 125^\circ\text{C}$	11
$V_{GE(th)}$	Gate Threshold Voltage	4.0	5.0	6.0		$V_{CE} = V_{GE}, I_C = 250\mu A$	8, 9
$\Delta V_{GE(th)}/\Delta T_J$	Temperature Coeff. of Threshold Voltage	—	-12	—	mV/ $^\circ\text{C}$	$V_{CE} = V_{GE}, I_C = 1.0mA, (25^\circ\text{C}-125^\circ\text{C})$	10, 11
g_{fe}	Forward Transconductance	—	30.5	—	S	$V_{CE} = 50V, I_C = 40A, PW=80\mu s$	
I_{CES}	Zero Gate Voltage Collector Current	—	—	500	μA	$V_{GE} = 0V, V_{CE} = 1200V$	
		—	100	1200		$V_{GE} = 0V, V_{CE} = 1200V, T_J = 125^\circ\text{C}$	
I_{GES}	Gate-to-Emitter Leakage Current	—	—	± 100	nA	$V_{GE} = \pm 20V$	

Switching Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

	Parameter	Min.	Typ.	Max.	Units	Conditions	Ref.Fig.
Q_g	Total Gate Charge (turn-on)	—	340	510	nC	$I_C = 40A$	17
Q_{ge}	Gate - Emitter Charge (turn-on)	—	43	65		$V_{CC} = 600V$	CT1
Q_{gc}	Gate - Collector Charge (turn-on)	—	165	248		$V_{GE} = 15V$	
E_{on}	Turn-On Switching Loss	—	1400	1750	μJ	$I_C = 40A, V_{CC} = 600V$	CT4
E_{off}	Turn-Off Switching Loss	—	1650	2050		$V_{GE} = 15V, R_G = 4.7\Omega, L = 200\mu H$	WF1
E_{tot}	Total Switching Loss	—	3050	3800		$L_s = 150nH, T_J = 25^\circ\text{C}$	WF2
E_{on}	Turn-On Switching Loss	—	1950	2300	μJ	$T_J = 125^\circ\text{C}$	12, 14
E_{off}	Turn-Off Switching Loss	—	2200	2950		Energy losses include "tail" and diode reverse recovery.	
E_{tot}	Total Switching Loss	—	4150	5250			
$t_{d(on)}$	Turn-On Delay Time	—	76	99	ns	$I_C = 40A, V_{CC} = 600V$	13, 15
t_r	Rise Time	—	39	55		$V_{GE} = 15V, R_G = 4.7\Omega, L = 200\mu H$	CT4
$t_{d(off)}$	Turn-Off Delay Time	—	332	365		$L_s = 150nH, T_J = 125^\circ\text{C}$	WF1
t_f	Fall Time	—	25	33			WF2
C_{ies}	Input Capacitance	—	4300	—	pF	$V_{GE} = 0V$	16
C_{oes}	Output Capacitance	—	270	—		$V_{CC} = 30V$	
C_{res}	Reverse Transfer Capacitance	—	160	—		$f = 1.0MHz$	
RBSOA	Reverse Bias Safe Operating Area	FULL SQUARE				$T_J = 150^\circ\text{C}, I_C = 160A, V_p = 1200V$ $V_{CC} = 1000V, V_{GE} = +15V \text{ to } 0V$ $R_G = 4.7\Omega$	4
SCSOA	Short Circuit Safe Operating Area	10	—	—	μs	$T_J = 150^\circ\text{C}, V_p = 1200V$ $V_{CC} = 900V, V_{GE} = +15V \text{ to } 0V,$ $R_G = 4.7\Omega$	CT3 WF4

Note:

① $V_{CC} = 80\% (V_{CES}), V_{GE} = 20V, L = 100\mu H, R_G = 4.7\Omega.$

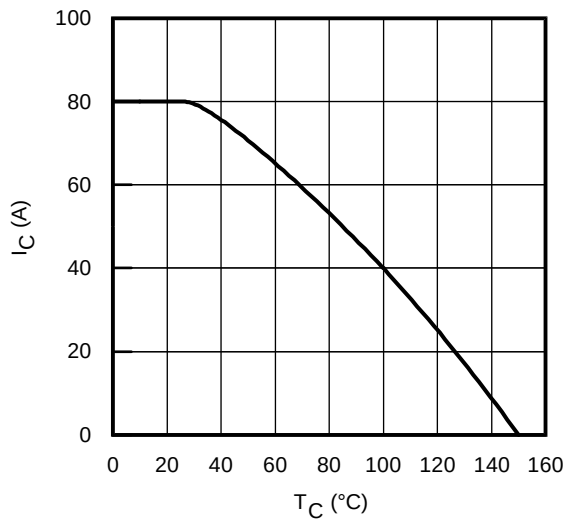


Fig. 1 - Maximum DC Collector Current vs. Case Temperature

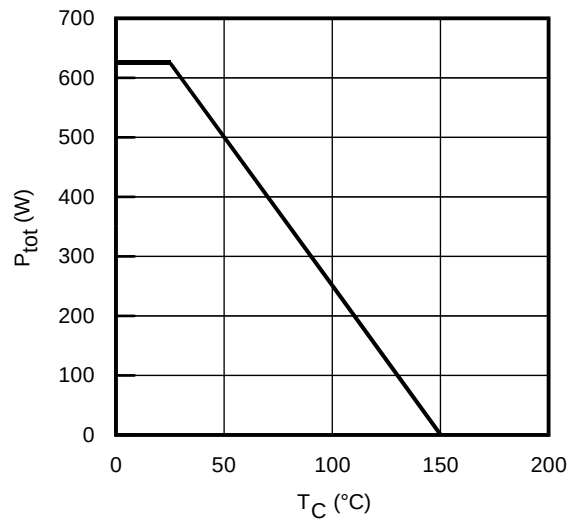


Fig. 2 - Power Dissipation vs. Case Temperature

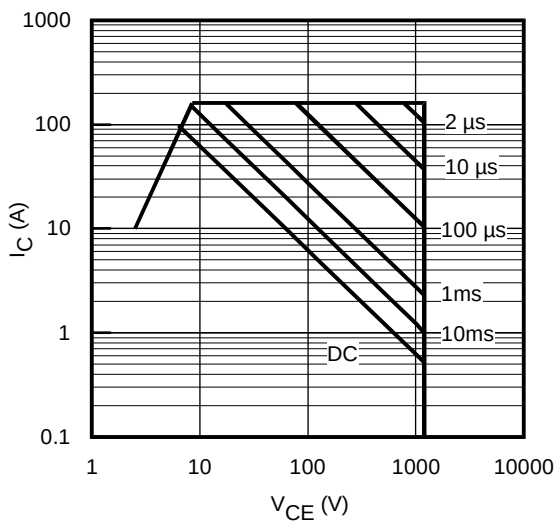


Fig. 3 - Forward SOA
 $T_C = 25^{\circ}\text{C}$; $T_{JS} \leq 150^{\circ}\text{C}$

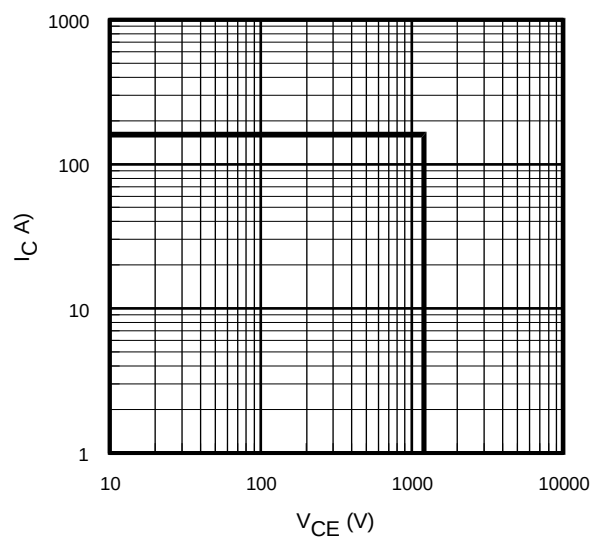


Fig. 4 - Reverse Bias SOA
 $T_J = 150^{\circ}\text{C}$; $V_{GE} = 15\text{V}$

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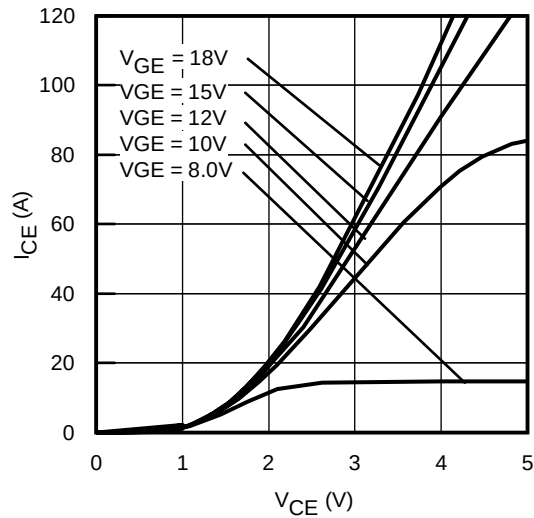


Fig. 5 - Typ. IGBT Output Characteristics
 $T_J = -40^\circ\text{C}$; $t_p = 80\mu\text{s}$

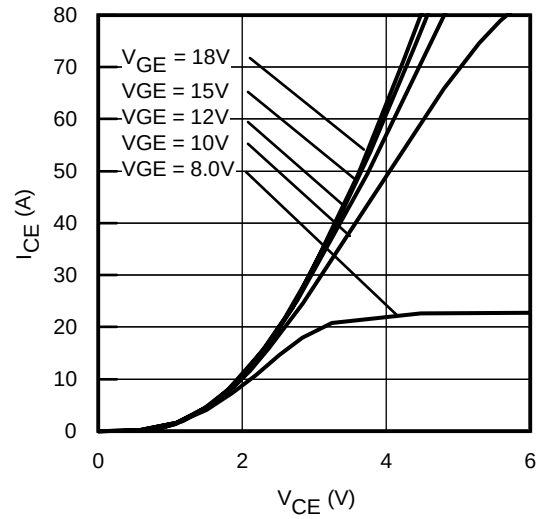


Fig. 6 - Typ. IGBT Output Characteristics
 $T_J = 25^\circ\text{C}$; $t_p = 80\mu\text{s}$

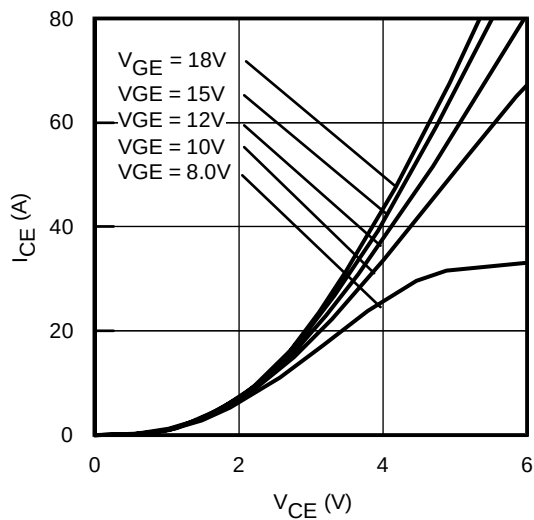


Fig. 7 - Typ. IGBT Output Characteristics
 $T_J = 125^\circ\text{C}$; $t_p = 80\mu\text{s}$

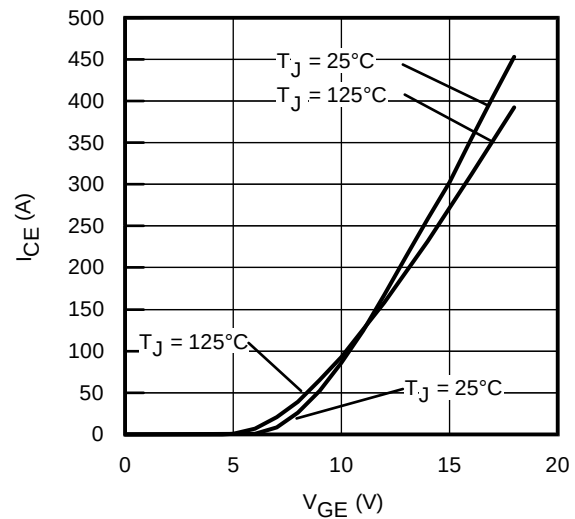


Fig. 8 - Typ. Transfer Characteristics
 $V_{CE} = 50\text{V}$; $t_p = 10\mu\text{s}$

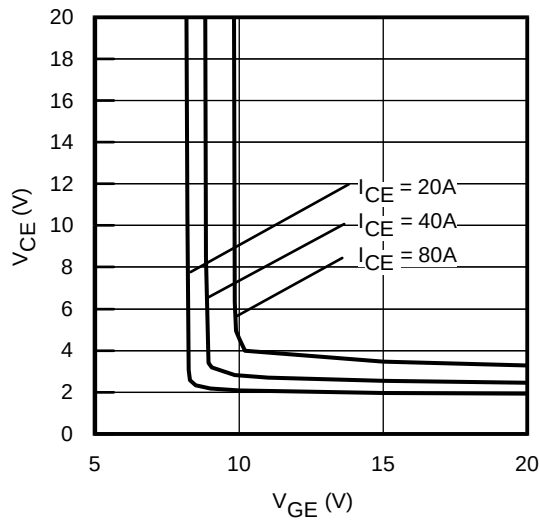


Fig. 9 - Typical V_{CE} vs. V_{GE}
 $T_J = -40^{\circ}\text{C}$

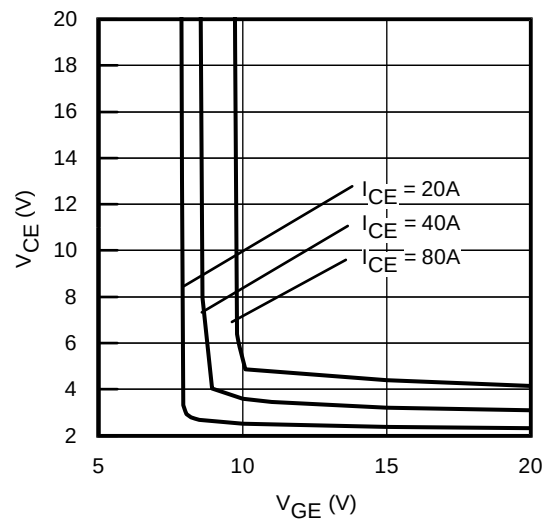


Fig. 10 - Typical V_{CE} vs. V_{GE}
 $T_J = 25^{\circ}\text{C}$

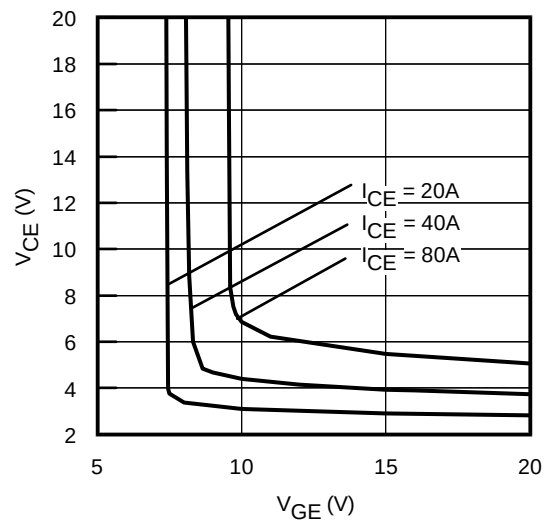


Fig. 11 - Typical V_{CE} vs. V_{GE}
 $T_J = 125^{\circ}\text{C}$

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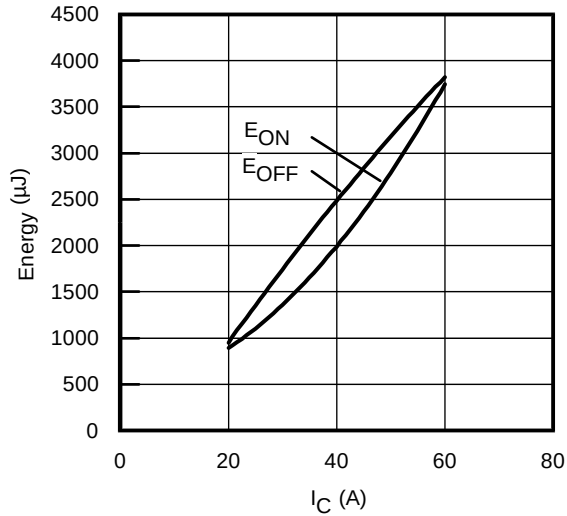


Fig. 12 - Typ. Energy Loss vs. I_C
 $T_J = 125^\circ\text{C}$; $L=200\mu\text{H}$; $V_{CE}= 600\text{V}$
 $R_G= 4.7\Omega$; $V_{GE}= 15\text{V}$

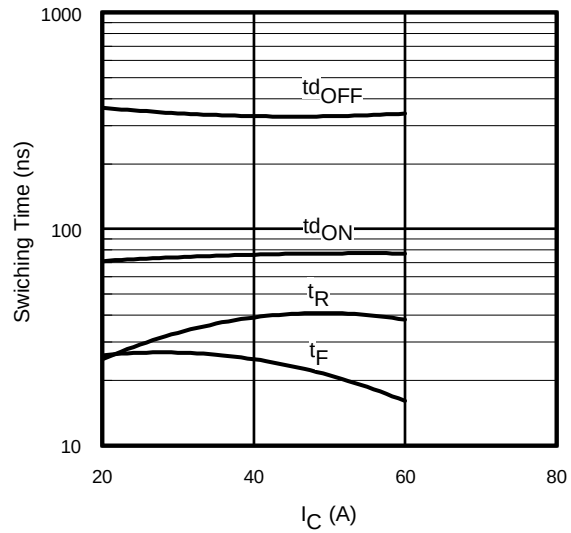


Fig. 13 - Typ. Switching Time vs. I_C
 $T_J = 125^\circ\text{C}$; $L=200\mu\text{H}$; $V_{CE}= 600\text{V}$
 $R_G= 4.7\Omega$; $V_{GE}= 15\text{V}$

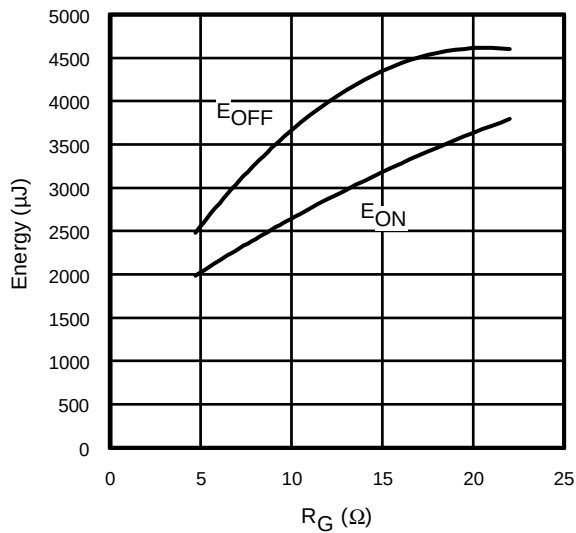


Fig. 14 - Typ. Energy Loss vs. R_G
 $T_J = 125^\circ\text{C}$; $L=200\mu\text{H}$; $V_{CE}= 600\text{V}$
 $I_{CE}= 40\text{A}$; $V_{GE}= 15\text{V}$

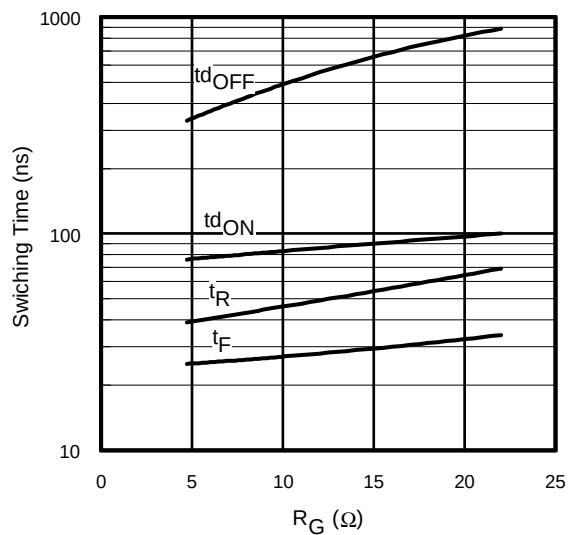


Fig. 15 - Typ. Switching Time vs. R_G
 $T_J = 125^\circ\text{C}$; $L=200\mu\text{H}$; $V_{CE}= 600\text{V}$
 $I_{CE}= 40\text{A}$; $V_{GE}= 15\text{V}$

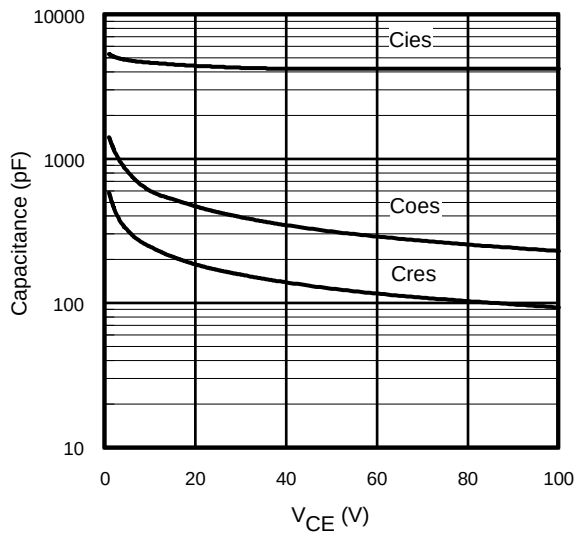


Fig. 16- Typ. Capacitance vs. V_{CE}
 $V_{GE} = 0V$; $f = 1MHz$

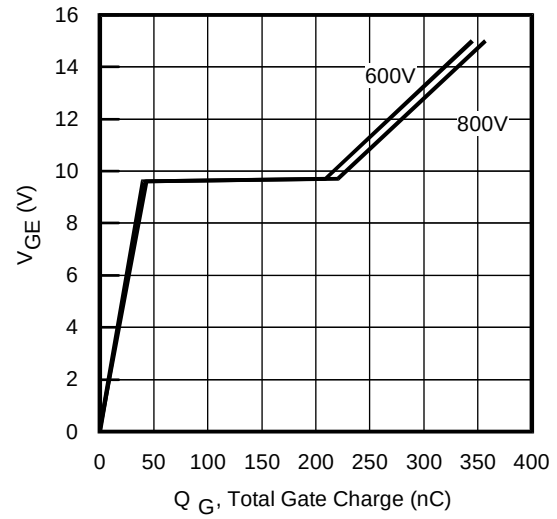


Fig. 17 - Typical Gate Charge vs. V_{GE}
 $I_{CE} = 40A$; $L = 600\mu H$

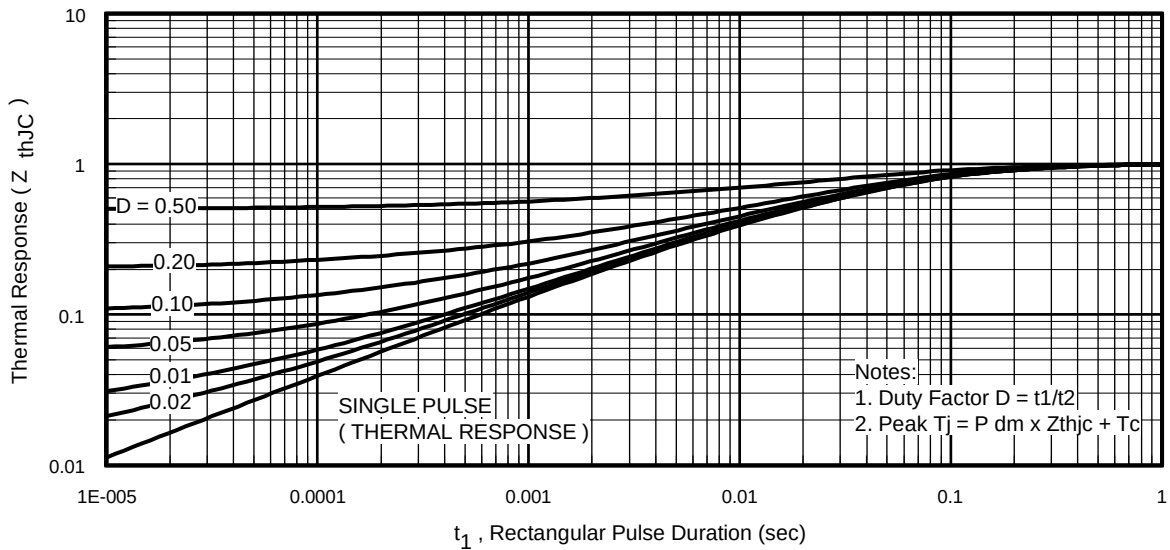


Fig 18. Normalized Transient Thermal Impedance, Junction-to-Case (IGBT)

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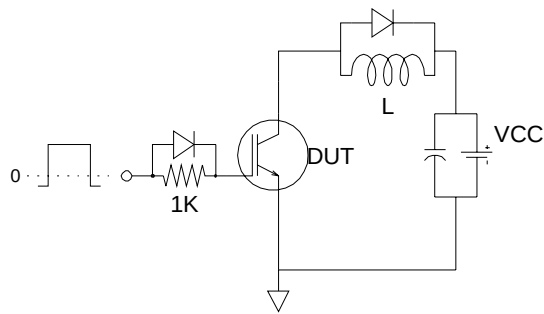


Fig.C.T.1 - Gate Charge Circuit (turn-on)

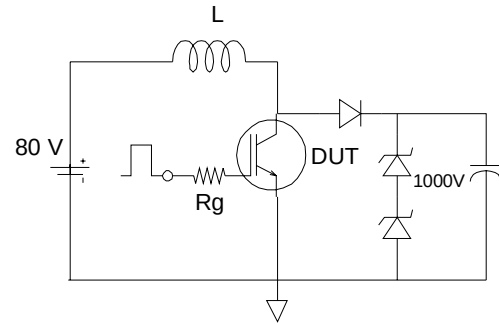


Fig.C.T.2 - RBSOA Circuit

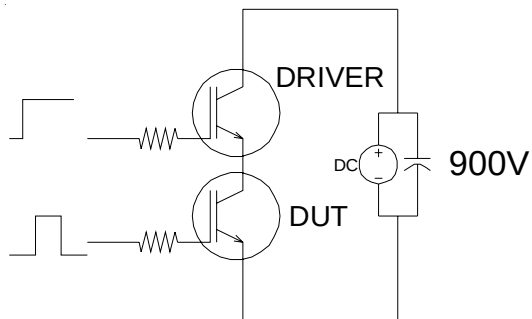


Fig.C.T.3 - S.C. SOA Circuit

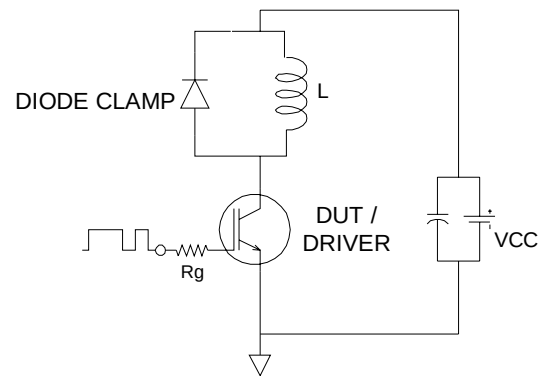


Fig.C.T.4 - Switching Loss Circuit

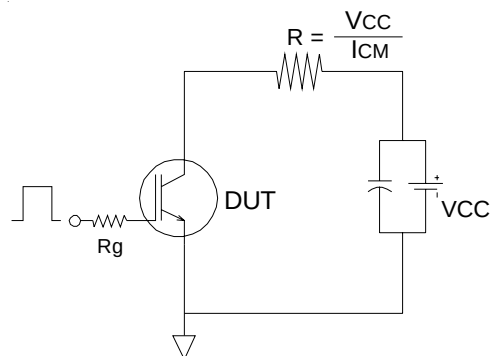


Fig.C.T.5 - Resistive Load Circuit

Fig. WF.1 - Typ. Turn-off Loss Waveform
@ $T_j=125^\circ\text{C}$ using Fig. CT.4

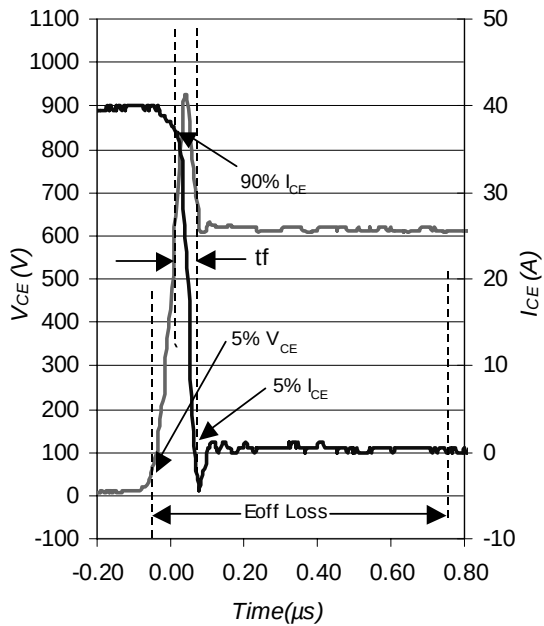


Fig. WF.2 - Typ. Turn-on Loss Waveform
@ $T_j=125^\circ\text{C}$ using Fig. CT.4

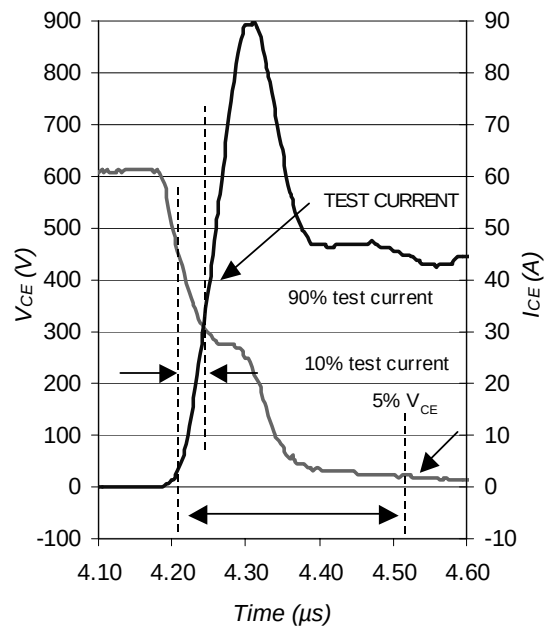
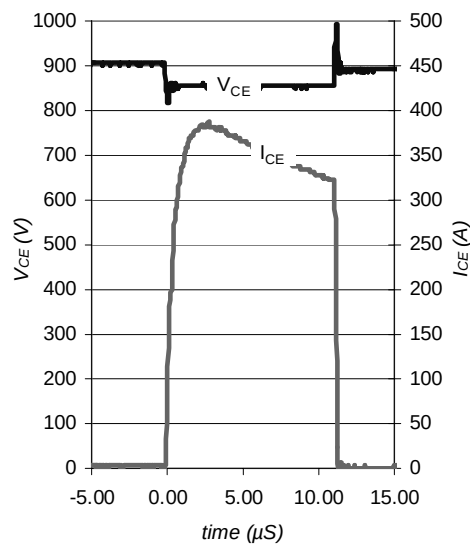


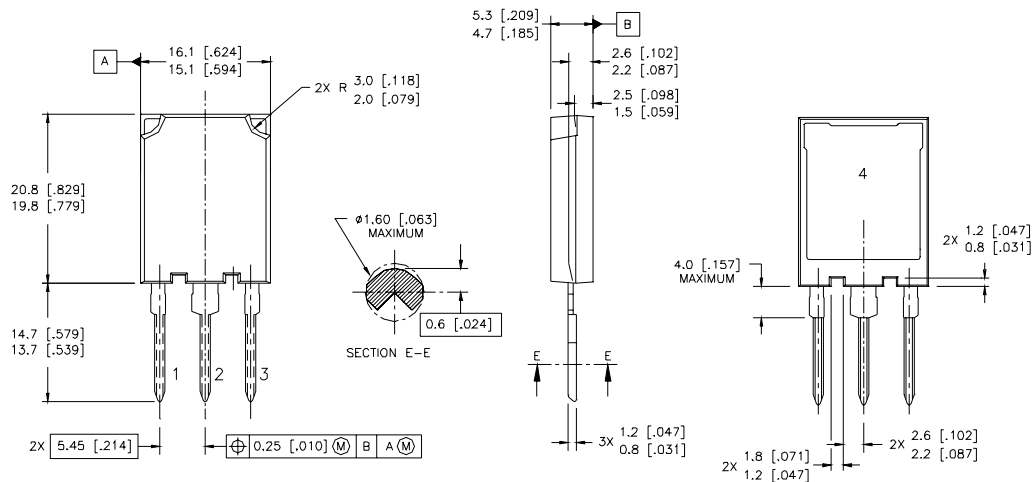
Fig. WF.3 - Typ. S.C. Waveform
@ $T_C=150^\circ\text{C}$ using Fig. CT.3



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Case Outline and Dimensions — Super-247

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NOTES:

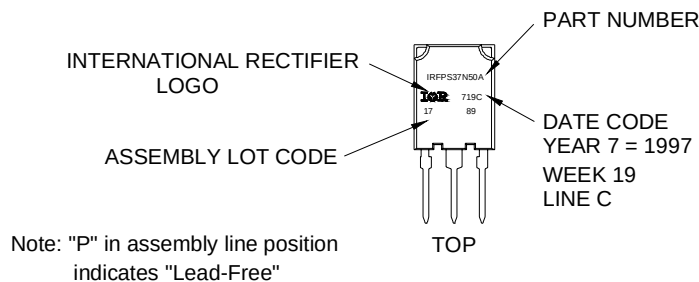
1. DIMENSIONS & TOLERANCING PER ASME Y14.5M-1994
2. CONTROLLING DIMENSION: MILLIMETER
3. DIMENSIONS ARE SHOWN IN MILLIMETRES [INCHES]

LEAD ASSIGNMENTS

MOSFET	IGBT
1 - GATE	1 - GATE
2 - DRAIN	2 - COLLECTOR
3 - SOURCE	3 - EMITTER
4 - DRAIN	4 - COLLECTOR

Super-247 (TO-274AA) Part Marking Information

EXAMPLE: THIS IS AN IRFPS37N50A WITH
ASSEMBLY LOT CODE 1789
ASSEMBLED ON WW 19, 1997
IN THE ASSEMBLY LINE "C"



Data and specifications subject to change without notice.
This product has been designed and qualified for the industrial market.
Qualification Standards can be found on IR's Web site.

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